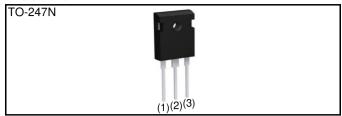


# SCT3160KL

## **N-channel SiC power MOSFET**

$V_{\mathrm{DSS}}$	1200V
R <sub>DS(on)</sub> (Typ.)	160mΩ
I <sub>D</sub> <sup>*1</sup>	17A
$P_{D}$	103W

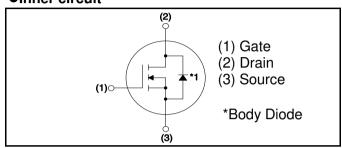
#### Outline



#### Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive
- 6) Pb-free lead plating; RoHS compliant

#### •Inner circuit



### Application

- · Solar inverters
- DC/DC converters
- Switch mode power supplies
- · Induction heating
- Motor drives

### Packaging specifications

	Packing	Tube
	Reel size (mm)	ı
Typo	Tape width (mm)	ı
Type	Basic ordering unit (pcs)	30
	Taping code	C11
	Marking	SCT3160KL

## ● **Absolute maximum ratings** (T<sub>vj</sub> = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit
Drain - Source Voltage		$V_{DSS}$	1200	V
Continuous Drain current	T <sub>c</sub> = 25°C	I <sub>D</sub> *1	17	А
Continuous Drain current	T <sub>c</sub> = 100°C	I <sub>D</sub> *1	12	А
Pulsed Drain current (T <sub>c</sub> = 25°C)		I <sub>D,pulse</sub> <sup>*2</sup> 42		Α
Gate - Source voltage (DC)		$V_{GSS}$	-4 to +22	V
Gate - Source surge voltage (t <sub>surge</sub> < 300nsec)		V <sub>GSS_surge</sub> *3	-4 to +26	V
Recommended drive voltage		V <sub>GS_op</sub> *4	0 / +18	V
Virtual Junction temperature		T <sub>vj</sub>	175	°C
Range of storage temperature		T <sub>stg</sub>	-55 to +175	°C

# ullet Electrical characteristics ( $T_{vj} = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
- raiametei	Symbol		Min.	Тур.	Max.	Offic
		$V_{GS} = 0V$ , $I_D = 1mA$				
Drain - Source breakdown voltage	$V_{(BR)DSS}$	$T_{vj} = 25^{\circ}C$	1200	-	-	V
		$T_{vj} = -55^{\circ}C$	1200	-	-	
		$V_{GS} = 0V, V_{DS} = 1200V$				
Zero Gate voltage Drain current	I <sub>DSS</sub>	$T_{vj} = 25^{\circ}C$	-	1	10	μΑ
Drain current		$T_{vj} = 150$ °C	-	2	-	
Gate - Source leakage current	I <sub>GSS+</sub>	$V_{GS} = +22V$ , $V_{DS} = 0V$	ı	ı	100	nA
Gate - Source leakage current	I <sub>GSS-</sub>	$V_{GS} = -4V$ , $V_{DS} = 0V$	ı	ı	-100	nA
Gate threshold voltage	V <sub>GS (th)</sub>	$V_{DS} = 10V, I_{D} = 2.5mA$	2.7	ı	5.6	V
		$V_{GS} = 18V, I_{D} = 5A$				
Static Drain - Source on - state resistance	R <sub>DS(on)</sub> *5	$T_{vj} = 25^{\circ}C$	-	160	208	mΩ
on state resistance		$T_{vj} = 150$ °C	-	272	-	
Gate input resistance	$R_{G}$	f = 1MHz, open drain	-	18	-	Ω

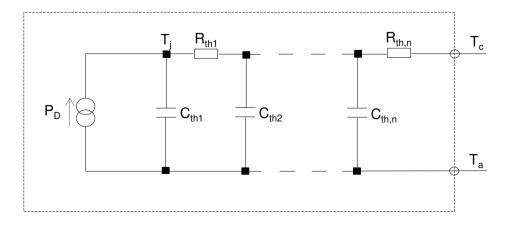
#### ●Thermal resistance

Parameter	Symbol	Values			Unit
raidiletei		Min.	Тур.	Max.	Offic
Thermal resistance, junction - case	$R_{thJC}$	-	1.12	1.46	K/W

●Typical Transient Thermal Characteristics

Symbol	Value	Unit
R <sub>th1</sub>	1.11E-01	
R <sub>th2</sub>	7.09E-01	K/W
R <sub>th3</sub>	3.01E-01	

Symbol	Value	Unit
C <sub>th1</sub>	8.73E-04	
C <sub>th2</sub>	5.10E-03	Ws/K
$C_{th3}$	2.94E-02	



# ullet Electrical characteristics ( $T_{vj} = 25^{\circ}C$ unless otherwise specified)

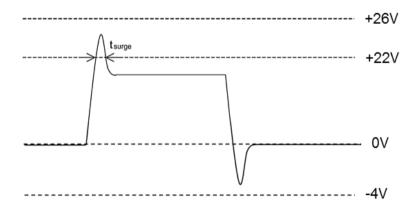
Parameter	Cumbal	Conditions	Values		'alues	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Transconductance	g <sub>fs</sub> *5	$V_{DS} = 10V, I_{D} = 5A$	-	2.5	-	S
Input capacitance	$C_{iss}$	$V_{GS} = 0V$	-	398	-	
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 800V	-	41	-	pF
Reverse transfer capacitance	$C_{rss}$	f = 1MHz	-	18	-	
Effective output capacitance, energy related	$C_{o(er)}$	$V_{GS} = 0V$ $V_{DS} = 0V \text{ to } 600V$	-	45	-	pF
Total Gate charge	$Q_g^{*5}$	$V_{DS} = 600V$ $I_{D} = 5A$	ı	42	-	
Gate - Source charge	Q <sub>gs</sub> *5	$V_{GS} = 18V$	-	10	-	nC
Gate - Drain charge	$Q_{gd}^{*5}$	See Fig. 1-1.	ı	22	1	
Turn - on delay time	t <sub>d(on)</sub> *5	$V_{DS} = 400V$ $I_{D} = 5A$	-	14	-	
Rise time	t <sub>r</sub> *5	$V_{GS} = 0V/+18V$	-	18	-	
Turn - off delay time	t <sub>d(off)</sub> *5	$R_G = 0\Omega$ $R_L = 80\Omega$	-	24	-	ns
Fall time	t <sub>f</sub> *5	See Fig. 1-1, 1-2.	ı	25	-	
Turn - on switching loss	E <sub>on</sub> *5	$V_{DS} = 600V$ $V_{GS} = 0V/18V$ , $I_D = 5A$ $R_G = 0\Omega$ , $L = 750\mu H$	-	62	-	1
Turn - off switching loss	E <sub>off</sub> *5	$E_{on}$ includes diode reverse recovery $L_{\sigma}$ = 50nH, $C_{\sigma}$ = 200pF See Fig. 2-1, 2-2.	-	12	-	· μJ

## ullet Body diode electrical characteristics (Source-Drain) ( $T_{vj} = 25^{\circ}$ C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
raiailletei	Symbol	Conditions	Min.	Тур.	Max.	Offic
Body diode continuous, forward current	I <sub>S</sub> *1	T <sub>c</sub> = 25°C	-	-	17	Α
Body diode direct current, pulsed	I <sub>SM</sub> *2	1 <sub>c</sub> = 23 0	ı	i	42	Α
Forward voltage	V <sub>SD</sub> *5	$V_{GS} = 0V$ , $I_{S} = 5A$	-	3.2	ı	V
Reverse recovery time	t <sub>rr</sub> *5	$I_F = 5A$ $V_B = 600V$	-	13	ı	ns
Reverse recovery charge	Q <sub>rr</sub> *5	di/dt = 1100A/µs	ı	26	ı	nC
Peak reverse recovery current	l <sub>rrm</sub> *5	$L_{\sigma} = 50$ nH, $C_{\sigma} = 200$ pF See Fig. 3-1, 3-2.	-	4	-	Α

<sup>\*1</sup> Limited by maximum  $T_{\nu j}$  and for Max.  $R_{thJC}.$ 

## \*3 Example of acceptable $V_{\text{GS}}$ waveform



\*5 Pulsed

<sup>\*2</sup> PW  $\leq$  10 $\mu$ s, Duty cycle  $\leq$  1%

 $<sup>^{\</sup>star}4$  Please be advised not to use SiC-MOSFETs with  $V_{\text{GS}}$  below 13V as doing so may cause thermal runaway.

Fig.1 Power Dissipation Derating Curve

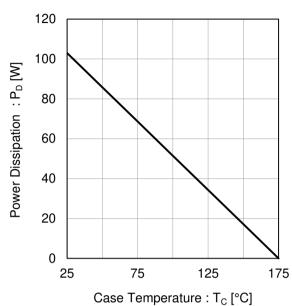


Fig.2 Maximum Safe Operating Area

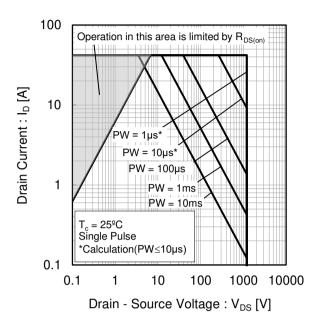
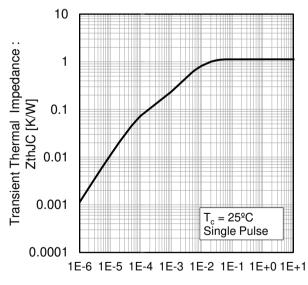


Fig.3 Typical Transient Thermal Resistance vs. Pulse Width



Pulse Width: PW [s]

Fig.4 Typical Output Characteristics(I)

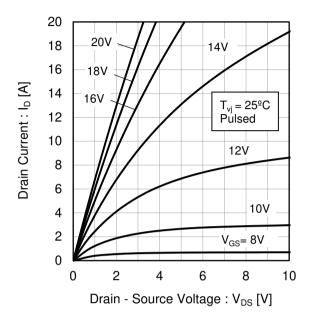


Fig.5 Typical Output Characteristics(II)

Datasheet

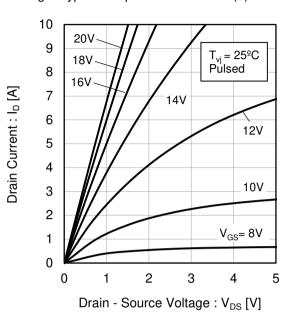
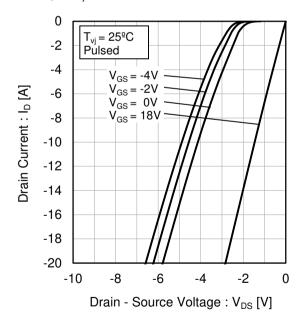
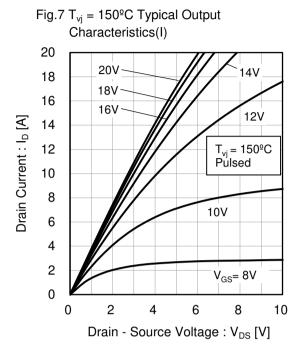


Fig.6 T<sub>vj</sub> = 25°C 3rd Quadrant Characteristics





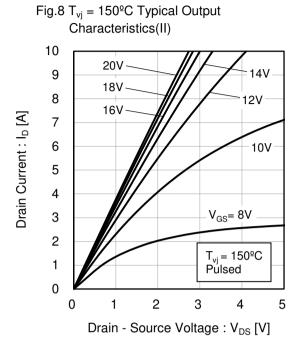


Fig.9  $T_{vj} = 150^{\circ}C$  3rd Quadrant Characteristics

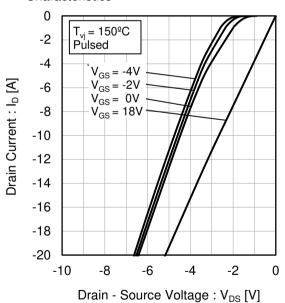


Fig.10 Body Diode Forward Voltage vs. Gate - Source Voltage

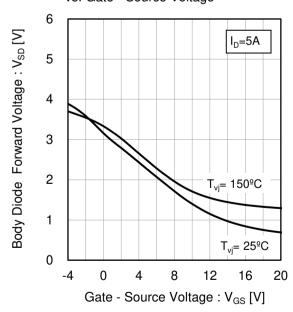


Fig.11 Typical Transfer Characteristics (I)

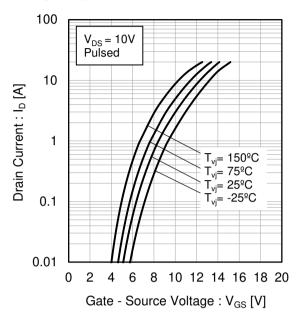


Fig.12 Typical Transfer Characteristics (II)

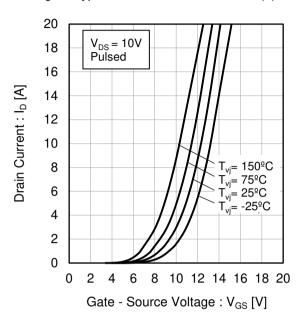


Fig.13 Gate Threshold Voltage vs. Junction Temperature

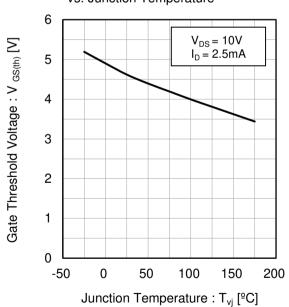
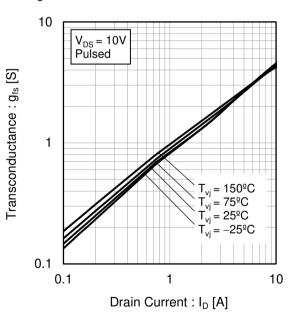


Fig.14 Transconductance vs. Drain Current



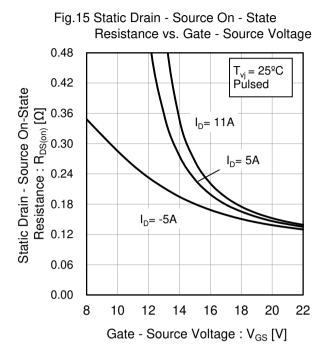
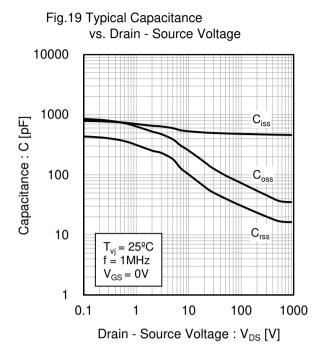


Fig.16 Static Drain - Source On - State Resistance vs. Junction Temperature 0.48  $V_{GS} = 18V$ Pulsed 0.42 Static Drain - Source On-State  $\begin{array}{c} \text{Resistance: R}_{\text{DS(on)}} \, [0] \\ \text{0.30} \\ \text{0.18} \\ \text{0.12} \\ \end{array}$  $I_D = 11A$  $I_D = 5A$  $I_D = -5A$ 0.06 0.00 0 100 200 -50 50 150 Junction Temperature : T<sub>vi</sub> [°C]

Fig.17 Static Drain - Source On - State Resistance vs. Drain Current 1 Static Drain - Source On-State Resistance:  $R_{DS(on)}$  [ $\Omega$ ] 0.1 T<sub>vj</sub> = 150ºC  $T_{vj} = 125^{\circ}C$  $T_{vj}^{vj} = 75^{\circ}C$   $T_{vj} = 25^{\circ}C$ -25ºC  $V_{GS} = 18V$ Pulsed 0.01 10 100 Drain Current: ID [A]

Fig.18 Normalized Drain - Source Breakdown Voltage vs. Junction Temperature 1.04  $V_{GS} = 18V$ Pulsed 1.03 Normalized Drain - Source malized Drain Breakdown Voltage 0.99 0.98 0 50 -50 100 150 200 Junction Temperature : T<sub>vi</sub> [°C]

ROHM



16
T<sub>vj</sub> = 25°C

14

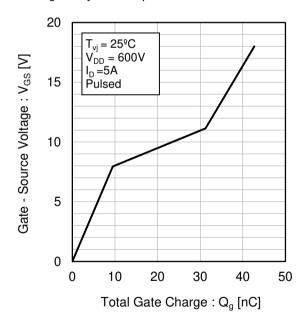
T<sub>vj</sub> = 25°C

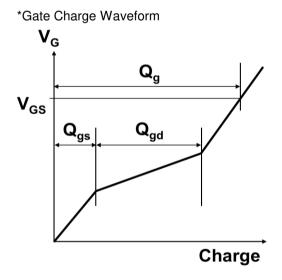
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Fig.20 Coss Stored Energy

Fig.21 Dynamic Input Characteristics





1 L 0.1

#### •Electrical characteristic curves

Fig.19 Typical Switching Time

1

10

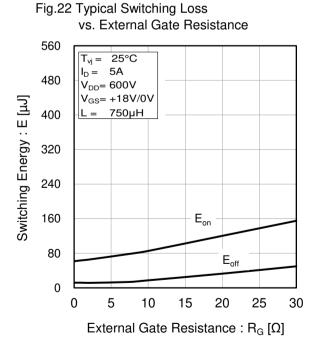
Drain Current: ID [A]

100

vs. Drain - Source Voltage 140  $T_{vj} = 25^{\circ}C$ 5A  $I_D =$ 120  $V_{GS} = +18V/0V$  $R_G = 0\Omega$ Switching Energy : E [μJ] L = 750µH 100 80  $E_{on}$ 60 40 20  $E_{off}$ 0 400 600 200 800 1000 Drain - Source Voltage: V<sub>DS</sub> [V]

Fig.20 Typical Switching Loss

Fig.21 Typical Switching Loss vs. Drain Current 560 25°C V<sub>DD</sub>= 600V 480  $V_{GS} = +18V/0V$ Switching Energy : E [µJ]  $R_G = 0\Omega$ 400 750µH 320 240 Eon 160 80  $\mathsf{E}_{\mathsf{off}}$ 0 2 8 10 12 14 16 18 20 4 Drain Current: I<sub>D</sub> [A]



#### Measurement circuits and waveforms

Fig.1-1 Gate Charge and Switching Time Measurement Circuit

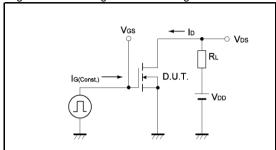


Fig.2-1 Switching Energy Measurement Circuit

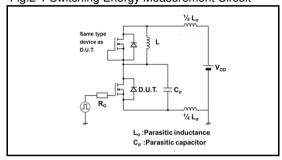


Fig.3-1 Reverse Recovery Time Measurement Circuit

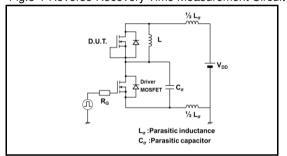


Fig.1-2 Waveforms for Switching Time

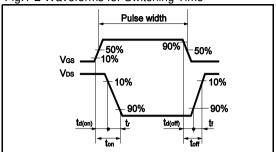


Fig.2-2 Waveforms for Switching Energy Loss

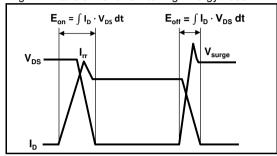
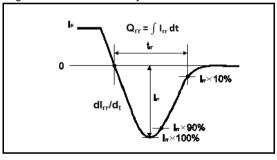
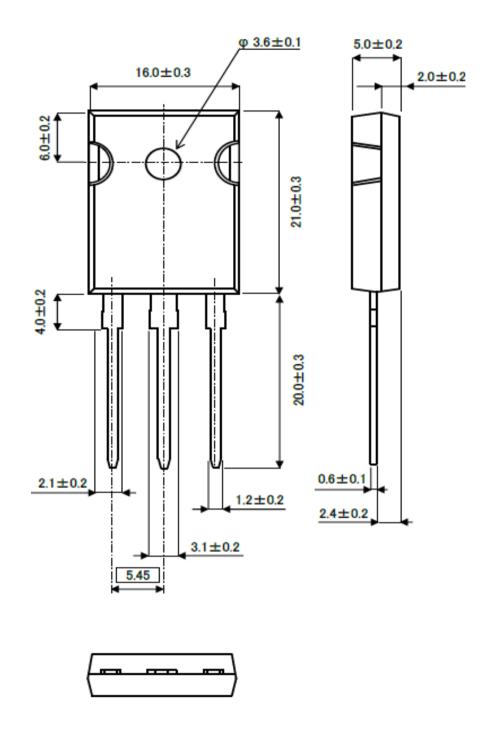


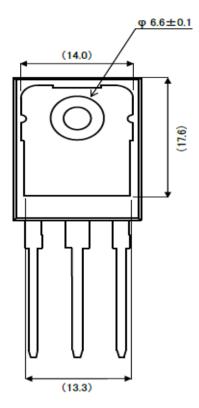
Fig.3-2 Reverse Recovery Waveform



### ●Package Dimensions

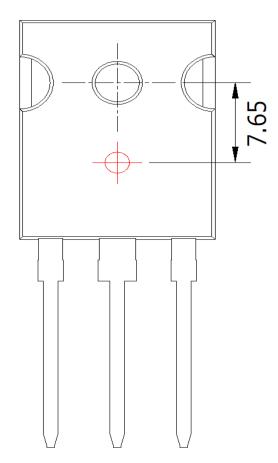


Unit: mm



Unit: mm

## **●**Die Bonding Layout





- •Front view of the packaging.
- •Dimensions are design values.
- •If the heat sink is to be installed, it should be in contact with the die bonding point.

Unit: mm

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